RECORDATION FORM COVER SHEET PATENTS ONLY						
DOCKET NUMBER: SC04895						
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.						
Name of conveying party(ies): Materials Ites	Name and address of receiving party(ies)					
Motorola, Inc.	Name: Freescale Semiconductor, Inc.					
	Internal Address: Law Department					
Additional name(s) of conveying party(ies) Additional name(s) of conveying party(ies) Yes X No attached?						
3 Name of conveyance: X Assignment Merger	Street Address: 6501 William Cannon Drive West					
Security Agreement Change of Name	City: Austin State: TX Zip: 78735					
Other						
Execution Date: Effective as of April 4, 2004	Additional name(s) & address(es) attached? Yes X No					
4. Application number(s) or patent number(s):	L					
A. Patent Application No.(s)	on, the execution date of the application is B. Patent No.(s)					
	4.548.654					
	4,546,054					
Additional numbers attache	ed? Yes X No					
 Name and address of party to whom correspondence concerning document should be mailed: 	6. Total number of applications and patents involved:					
Name: Freescale Semiconductor, Inc.	7. Total fee (37 CFR 3.41) \$40.00					
Internal Address:	Enclosed					
_ Law Department	See North arizonda de la constitución de la constit					
	X Authorized to be charged to deposit account					
Street Address: 7700 W. Parmer Lanc, MD: PL02	8. Deposit account number: 503079, Freescale Semiconductor, Inc.					
City: Austin	1					
State: TX Zip: 78729	(Artach duplicate copy of this page if paying by deposit account.)					
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9 Statement and signature.						
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document						
Kim-Marie Vo Kim-Marie Vo AW 29 2004						
Name of Person Signing Signature Date						
Total number of pages including cover sheet, attachments, and documents: 4						

Mail documents to be recorded with required cover sheet information to: Mail Stop Patent Application, Commissioner of Patents, P. O. Box 1450, Alexandria, VA 22313-1450

SC04895

PATENT ASSIGNMENT

This Patent Assignment is between Motorola, Inc. ("Assignor") and Freescale Semiconductor, Inc. ("Assignee"). Capitalized terms used in this Patent Assignment have the same meanings given to them in the Agreement.

- 1. For good and valuable consideration, receipt of which the Assignor acknowledges, and by signing and delivering this instrument, the Assignor sells, assigns, transfers, conveys, and delivers to the Assignce all of the Assignor's right, title, and interest in and to:
 - (a) the patents, patent applications and invention disclosures specifically listed in Schedule 1 to this Patent Assignment; and
 - (b) the following properties and rights with respect to all patents and patent applications so listed in Schedule 1:
 - the inventions claimed or described in the patents or applications,
 - (ii) any patents in the United States and anywhere else in the world and patent applications that have been or may be granted or filed, respectively, with respect to those inventions, including without limitation all foreign patents that may claim priority based on and correspond to the patents listed in Schedule 1,
 - (iii) all divisions, renewals, reissues, continuations, extensions, and (if filed by or for Assignee) continuations-in-part of the foregoing patents.
 - (iv) all income, royalties, damages, and payments due or payable to the Assignor with respect to the patents, including without limitation unpaid damages and payments for past, present, and future infringements of any patent and
 - (v) all rights to sue and recover damages and payments for past, present, and future infringements of any of the patents, including the right to fully and entirely replace the Assignor in all related matters.
- 2. The foregoing rights in and under the patents shall apply to the full end of their terms as fully as the Assignor would have held the same in the absence of this assignment. As of the date set forth below, the Assignee has succeeded to all right, title, and standing of the Assignor to (a) receive all rights and benefits pertaining to the patents described above, and (b) commence, prosecute, defend and settle all claims and take all actions that the Assignee, in its sole discretion, may elect in relation to the patents and rights described above.

PATENT REEL: 014797 FRAME: 0116 3. This Patent Assignment (a) is irrevocable and effective upon the Assignor's signature to and delivery of a manually signed copy of this instrument or facsimile or email transmission of the signature to this instrument in connection with the execution of the Agreement, if and only if the such execution occurs, (b) benefits and binds the parties to the Agreement and their respective successors and assignees.

The undersigned has signed this Patent Assignment effective as of April 4, 2004.

The midersigned has signed this ratent rassignment effective as arright in 200 in
Motorola, Inc.:
John My
By:
Name: Jonathan P. Meyer
Title: Senior Vice President and Assistant General Counsel
STATE OFIllinois
COUNTY OF COOK
On JUNE 24,2004 before me, Gabrielle Richard the undersigned notary) personally
notary), personally
appeared Jonathan P. Meyer personally known to me (or proved to me on the basis of
satisfactory evidence) to be the person whose name is subscribed to the within instrument
and acknowledged to me that he executed the same in his authorized capacity, and that by
his signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.
·
WITNESS my hand and official scal this 24th day of June, 2004.
I
My Commission Expires: Jaly elle Richards
/ July ille & chards

Notary Public Signature

Printed Name of Notary Public

OFFICIAL SEAL
GABRIELLE RICHARDS
HOTARY PUBLIC, STATE OF ALMONS
MY COMMESSION EXPERSIONALS

PATENT REEL: 014797 FRAME: 0117

SCHEDULE 1

TO PATENT ASSIGNMENT AGREEMENT

Country	Docket Number	Patent Number	Grant Date	Title
				•
USA	SC04895	4548654	10/22/1985	Surface Denuding of Silicon Wafer

PATENT REEL: 014797 FRAME: 0118

RECORDED: 06/29/2004